



PATENT

Case Docket No. ASMEX.236A

Date: September 30, 2002

Page 1

In re application of : Raaijmakers et al.  
App. No. : 09/658,784  
Filed : September 11, 2000  
For : LOADLOCK WITH  
INTEGRATED PRE-CLEAN  
CHAMBER  
Examiner : R. Zervigon  
Art Unit : 1763

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September 30, 2002

Gordon H. Olson, Reg. No. 20,319

UNITED STATES PATENT AND TRADEMARK OFFICE BOX AF  
P.O. Box 2327  
Arlington, VA 22202

Sir:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated as shown below:

CLAIMS AS FILED						
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total Claims	74	—	65	= 9 ×	\$18	= \$162
Independent Claims	8	—	9	= 0 ×	\$84	= \$0
Time Extension Fee						\$0
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT						\$162

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Gordon H. Olson  
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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Raaijmakers et al. ) Group Art Unit: 1763  
Appl. No. : 09/658,784 )  
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AMENDMENT AFTER FINAL UNDER 37 C.F.R. § 1.116

Assistant Commissioner for Patents  
Washington, D.C. 20231

Dear Sir:

In response to the Final Office Action mailed July 21, 2002, Applicant respectfully submits the following amendments and comments in connection with the above-captioned application.

IN THE SPECIFICATION:

Please amend the paragraph starting at page 16, line 13, as follows:

The elevator mechanism moves the second elevator plate 402 between an outside position where the wafer carrier 50 is located outside the load lock 400 (see Figure 11A) and a sealed position where the wafer carrier 50 is located within the load lock 400 (see Figure 11B). In this sealed position, the second elevator plate 402 substantially closes the load lock port 34. Preferably, the second elevator plate 402 includes a sealing portion 406, which cooperates with a corresponding sealing portion 408 formed on the load lock 400 to substantially seal the load lock port 34.

10/07/2002 AWONDAF1 00000095 09658784

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